

16-way Single L-band Active LD Series Combiner

The compact 16-way active combiner is part of the LD Combiner Series and is designed to provide affordable L-band combining in a 1U high, 19" rack mountable chassis.

Covering the full range of L-band, 850-2150MHz, this shelf also offers dual redundant power supplies for reliability in service.

Front panel LED's indicate the condition of the dual redundant power supplies.

This unit is available in a range of impedances and RF connectors (not N-type RF connectors).





Rear View of model C1601S1ULA-22280-B5B5

Key Features

- Housed in a compact 1U high chassis
- Front panel status LEDs for PSU status
- Dual redundant power supplies



RF Specifications						
Capacity		16 way Combiner				
Frequency Range		850 - 2150 MHz (L-band)				
RF Connectors		50Ω SMA	50Ω BNC	75Ω BNC	75Ω F-type	
Gain		0±1.5 dB	0±1.5 dB	0±1.5 dB	0±1.5 dB	
Gain Flatness	Full Band	±1.0 dB	±1.0 dB	±1.25 dB	±1.5 dB	
	Any 36 MHz	±0.5 dB	±0.5 dB	±0.75 dB	±1.0 dB	
Input Return Loss	Typical	18 dB	15 dB	12 dB	12 dB	
	Minimum	15 dB	12 dB	9 dB	9 dB	
Output Return Loss	Typical	15 dB	15 dB	12 dB	12 dB	
	Minimum	12 dB	12 dB	9 dB	9 dB	
Isolation		25 dB				
Noise Figure		26 dB				
1dB GCP		10 dBm				
OIP3		20 dBm 3rd order intercept point, output power				

System Control			
Display	Front panel LEDs for PSU status		

Power				
AC Power	85-264Vac 50-60Hz, Fused 2A			
AC Consumption	10W Max AC Input			
PSU	Dual redundant (Single AC Inlet. Diode OR. Not Hot Swap)			
Hot-swap PSU	No			

Environmental & Physical				
Temperature	Operating temp: 0 to 45°C Storage temp: -20°C to +75°C			
Location	Indoor use only			
Humidity	20 –90% non-condensing			
Altitude	10,000 feet AMSL (above mean sea level)			
Dimensions	1U high x 200mm deep x 19" wide			
Weight	2 kg			
Colour	White 00-E-55 semi-gloss			

Note 2: Operation beyond the quoted limits stated above may cause instantaneous and permanent damage.

Note 1: The specification is subject to regular reviews and will be updated from time to time as part of our continuing product development and improved spec accuracy.